ESH3B-M3, ESH3C-M3, ESH3D-M3

Vishay General Semiconductor

COMPLIANT

HALOGEN

FREE

Surface Mount Ultrafast Plastic Rectifier



DO-214AB (SMC)

PRIMARY CHARACTERISTICS					
I _{F(AV)}	3.0 A				
V _{RRM} 100 V, 150 V, 200 V					
t _{rr}	25 ns				
V _F	0.90 V				
T _J max.	175 °C				
Package	DO-214AB (SMC)				
Diode variations	Single die				

FEATURES

- Glass passivated pellet chip junction
- · Ideal for automated placement
- Ultrafast recovery times for high efficiency
- Low forward voltage, low power loss
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converter and inverter for both consumer, and automotive.

MECHANICAL DATA

Case: DO-214AB (SMC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	ESH3B	ESH3C	ESH3D	UNIT	
Device marking code		EHB	EHC	EHD		
Maximum repetitive peak reverse voltage	V_{RMM}	100	150	200		
Maximum RMS voltage	V_{RMS}	70	105	140	V	
Maximum DC blocking voltage	V_{DC}	100	150	200		
Maximum average forward rectified current (fig. 1)	I _{F(AV)}	3.0				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	125			А	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175			°C	



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	VALUE	UNIT	
Maximum instantaneous forward voltage	I _F = 3 A		V _F ⁽¹⁾	0.90	V	
Maximum DC reverse current		T _A = 25 °C	I_	5.0	μΑ	
at rated DC blocking voltage		T _A = 125 °C	I _R	150		
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A		t _{rr}	25		
Typical reverse recovery time	$I_F = 3 \text{ A, } V_R = 30 \text{ V,}$ $dI/dt = 50 \text{ A/µs, } I_{rr} = 10 \% I_{RM}$	T _J = 25 °C	- t _{rr}	40	ns	
		T _J = 100 °C		55		
Typical stored charge	$I_F = 3 \text{ A}, V_R = 30 \text{ V},$	T _J = 25 °C	0	25	nC	
	$dI/dt = 50 \text{ A/}\mu\text{s}, I_{rr} = 10 \% I_{RM}$ $T_J = 100 ^{\circ}\text{C}$		- Q _{rr}	60	lic l	
Typical junction capacitance	4.0 V, 1 MHz		CJ	70	pF	

Note

 $^{^{(1)}\,}$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	ESH3B	ESH3C	ESH3D	UNIT
Typical they made registeries	R _{0JA} (1)	50			°C/W
Typical thermal resistance	R ₀ JL (1)		15		C/VV

Note

⁽¹⁾ Units mounted on PCB with 12.0 mm x 12.0 mm land areas

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
ESH3D-M3/57T	0.211	57T	850	7" diameter plastic tape and reel		
ESH3D-M3/9AT	0.211	9AT	3500	13" diameter plastic tape and reel		

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

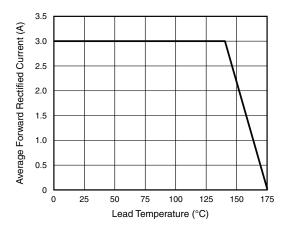


Fig. 1 - Maximum Forward Current Derating Curve

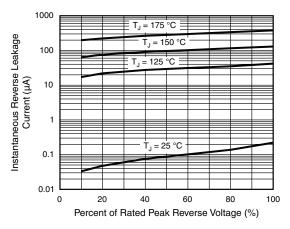


Fig. 4 - Typical Reverse Leakage Characteristics

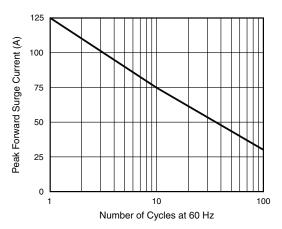


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

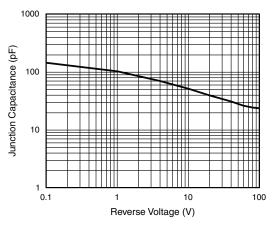


Fig. 5 - Typical Junction Capacitance

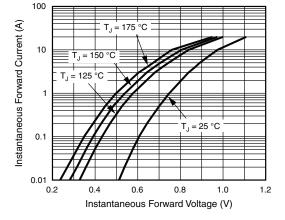


Fig. 3 - Typical Instantaneous Forward Characteristics

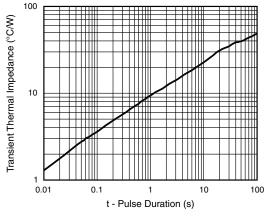


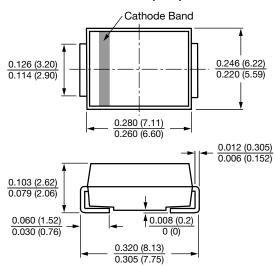
Fig. 6 - Typical Transient Thermal Impedance

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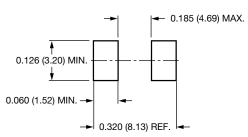
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AB (SMC)



Mounting Pad Layout





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